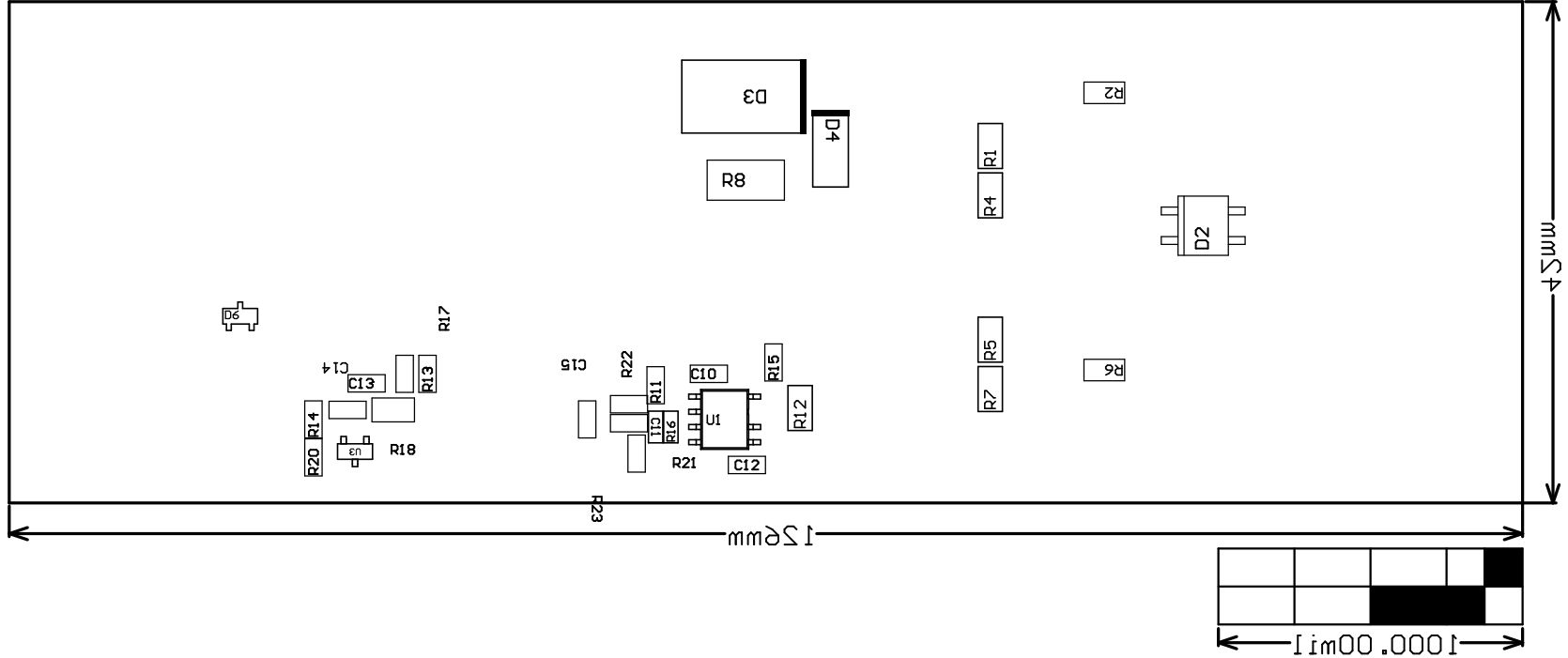


PCB VIEWED FROM TOP SIDE	BOARD #: PMP30285	REV:	SUN REV: Not In VersionControl
M2 Board Dimensions	TID #:		
PLOT NAME = Assembly Top	GENERATED : 8/9/2017	10:03:24 AM	TEXAS INSTRUMENTS



PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP30285	REV:	SUN REV: Not In VersionControl
	MS Board Dimensions # DIT		
PLOT NAME = Assembly Bottom	GENERATED : 8/9/2017	10:03:26 AM	TEXAS INSTRUMENTS

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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
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